# SN54LS21, SN74LS21 **DUAL 4-INPUT POSITIVE-AND GATES**

APRIL 1985 - REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic
- Dependable Texas Instruments Quality and Reliability

#### description

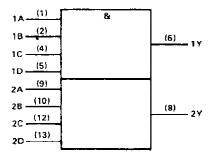
These devices contain two independent 4-input AND gates.

The SN54LS21 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74LS21 is characterized for operation from 0°C to 70°C.

## FUNCTION TABLE (each gate)

	INP	uts	ОИТРИТ	
А	В	С	D	Y
Н	Н	Н	Н	н
L	Х	Х	х	i.
Х	L	Х	×	L
Х	X	Ł	×	L
×	х	Х	L	L

# logic symbol<sup>†</sup>

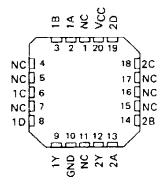


<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91 1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

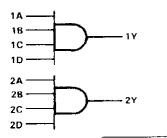
SN54LS21...J OR W PACKAGE SN74LS21...D OR N PACKAGE (TOP VIEW) 1A DI VIII VCC 1B □2 13 2D NC □3 12 2C 10 □4 11D NC 1D **□**5 10 2B 1Y 🛮 6 9 2A GND 7 8 2Y

### SN54LS21 . . . FK PACKAGE (TOP VIEW)



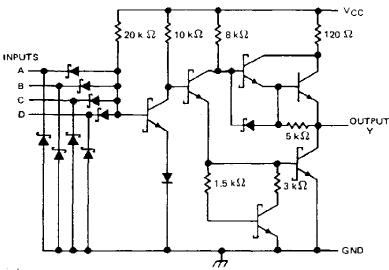
NC-No internal connection

#### logic diagram



(positive logic)  $Y = A \cdot B \cdot C \cdot D$  or  $Y = \overline{A + B + C} + \overline{D}$ 

#### schematics (each gate)



Resistor values shown are nominal.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	
Input voltage	, 7 V
Operating free-air temperature range: SN54'	
	0°C to 70°C
Storage temperature range	

NOTE 1: Voltage values are with respect to network ground terminals.

#### recommended operating conditions

		9	SN54LS21			SN74LS21		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	٧
V <sub>IH</sub>	High-level input voltage	2	••	-	2			
$\nu_{1L}$	Low-level input voltage			0.7			0.8	V
ф	High-level output current			- 0.4			- 0.4	mA
IOL	Low-level output current			4		-	8	mA
TA	Operating free-air temperature	<b>– 55</b>		125	0		- 70	°C

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# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	V <sub>CC</sub> = MIN, I <sub>I</sub> = - 18 mA		SN54LS21			SN74LS21				
			MIN	TYP‡	MAX	MIN	TYP\$	MAX	UNIT	
Vικ						- 1.5			1.5	v
voн	V <sub>CC</sub> ≈ MIN,	V <sub>IH</sub> ≠ 2 V,	I <sub>OH</sub> = - 0.4 mA	2.5	3,4		2.7	3.4		V
Va	V <sub>CC</sub> = MIN,	VIL = MAX,	IOL = 4 mA		0.25	0.4		0.25	0.4	V
V <sub>OL.</sub>	V <sub>CC</sub> = MIN,	V <sub>IL</sub> = MAX,	I <sub>OL</sub> ≈ 8 mA			-		0,35	0.5	
l <sub>1</sub>	V <sub>CC</sub> ≈ MAX,	V <sub>1</sub> = 7 V				0.1	<b>†</b>		0.1	mA
lн	V <sub>CC</sub> = MAX,	V <sub>1</sub> - 2.7 V		1		20	<b></b>		20	μА
اال	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V			<u>-</u>	- 0.4			- 0.4	mΑ
los§	V <sub>CC</sub> = MAX	<u> </u>		- 20		- 100	- 20		- 100	mA
<sup>I</sup> CCH	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 4.5 V			1.2	2.4		1.2	2.4	mA
ICCL	V <sub>CC</sub> = MAX,	ν <sub>1</sub> = 0 ν			2.2	4.4		2.2	4.4	mА

# switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	мах	UNIT
tРLН	Any	~	B. 7210 C 15.5		8	15	ns
<sup>t</sup> PHŁ	73114	,	R <sub>ξ</sub> = 2 kΩ, C <sub>L</sub> = 15 pF		10	20	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

f For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_{A} = 25^{\circ}\text{C}$ § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second,

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